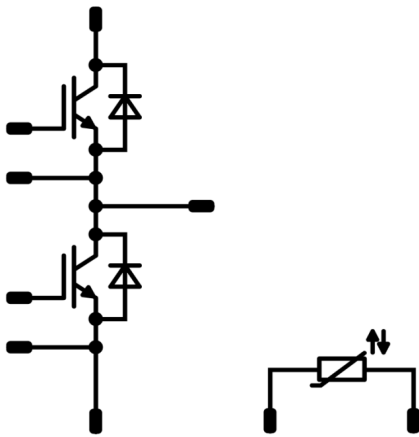




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MiniSkiiP® DUAL 2		650 V / 200 A
Features	MiniSkiiP® 2 Dual housing	
• Half-Bridge topology • Trench IGBT and CAL diode chip technology • Integrated NTC sensor • Solderless spring contact mounting system		
Target applications	Schematic	
• Industrial Drive • Power Supply • Solar • UPS		
Types		
• 80-M2072PA200SC-K705F40		

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Half-Bridge Switch				
Collector-emitter voltage	V_{CES}		650	V
Collector current	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	189	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	600	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	339	W
Gate-emitter voltage	V_{GES}		±20	V
Short circuit ratings	t_{SC} V_{CC}	$T_j \leq 150\text{ °C}$ $V_{GE} = 15\text{ V}$	6 360	µs V
Maximum junction temperature	T_{jmax}		175	°C



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Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Half-Bridge Diode				
Peak repetitive reverse voltage	V_{RRM}		650	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	204	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	271	W
Maximum junction temperature	T_{jmax}		175	°C

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{jop}		-40...(T_{jmax} - 25)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage $t_p = 2\text{ s}$	4000	V
Creepage distance			min. 12,7	mm
Clearance			min. 12,7	mm
Comparative Tracking Index	CTI		> 200	



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target datasheet

Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Half-Bridge Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,008	25	5,1	5,8	6,4	V
Collector-emitter saturation voltage	V_{CEsat}		15		180	25 150	0,93	1,45 1,70	1,77	V
Collector-emitter cut-off current	I_{CES}		0	650		25			10,8	μA
Gate-emitter leakage current	I_{GES}		20	0		25			1200	nA
Internal gate resistance	r_g							1		Ω
Input capacitance	C_{ies}	$f = 1 \text{ MHz}$	0	25		25		12320		pF
Reverse transfer capacitance	C_{res}							366		

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	Thermal grease thickness $\leq 50 \text{ μm}$ $\lambda = 1 \text{ W/mK}$						0,28		K/W
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Half-Bridge Diode

Static

Forward voltage	V_F				146	25 150		1,30 1,24	1,62 1,56	V
Reverse leakage current	I_R			650		25 150			180 52000	μA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	Thermal grease thickness $\leq 50 \text{ μm}$ $\lambda = 1 \text{ W/mK}$						0,35		K/W
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Thermistor

Rated resistance	R					25		5		kΩ
Deviation of R_{100}	$\Delta_{R/R}$	$R_{100} = 493 \text{ Ω}$				100	-5		+5	%
Power dissipation	P					25		245		mW
Power dissipation constant						25		1,4		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 2 \%$				25		3375		K
B-value	$B_{(25/100)}$	Tol. $\pm 2 \%$				25		3437		K
Vincotech NTC Reference									K	

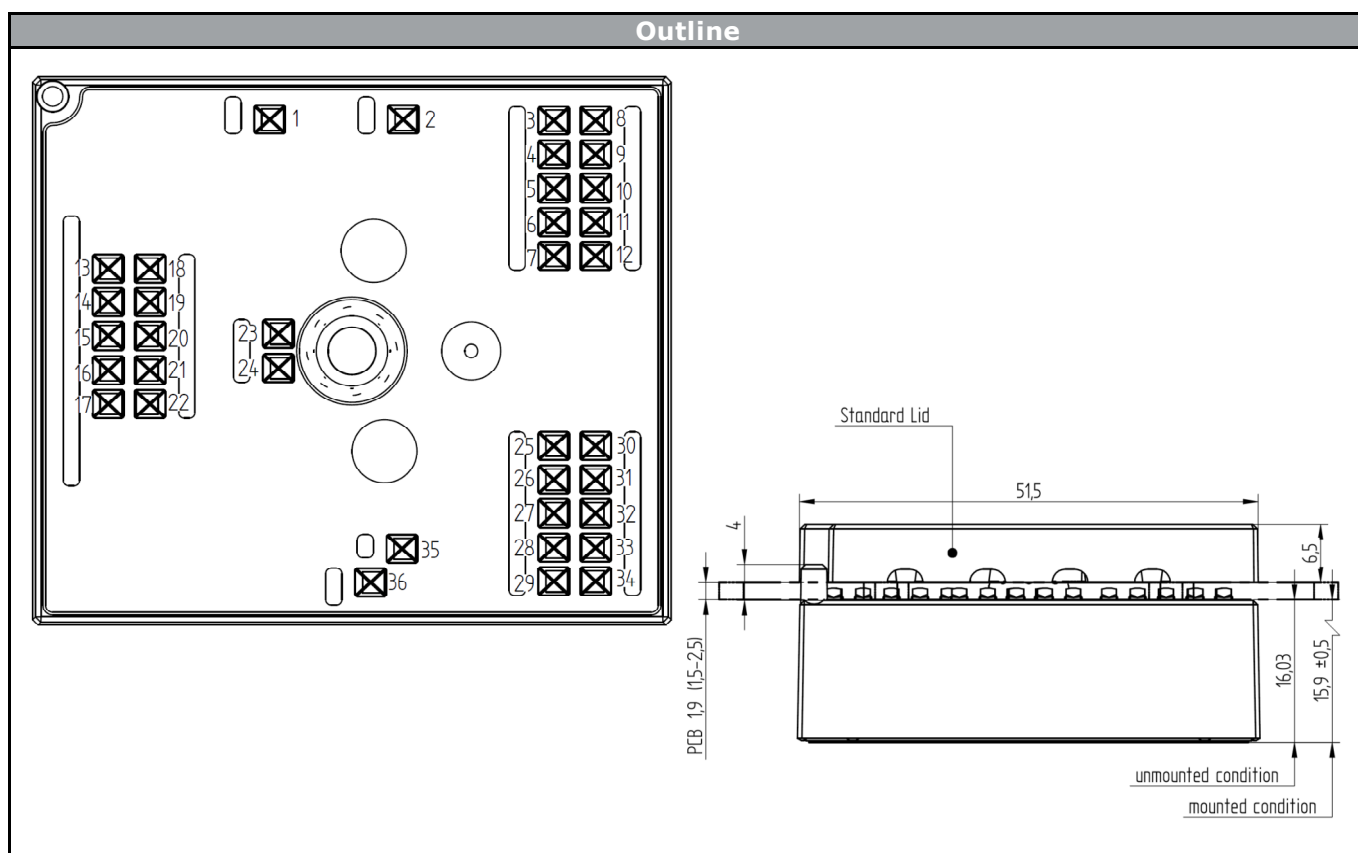


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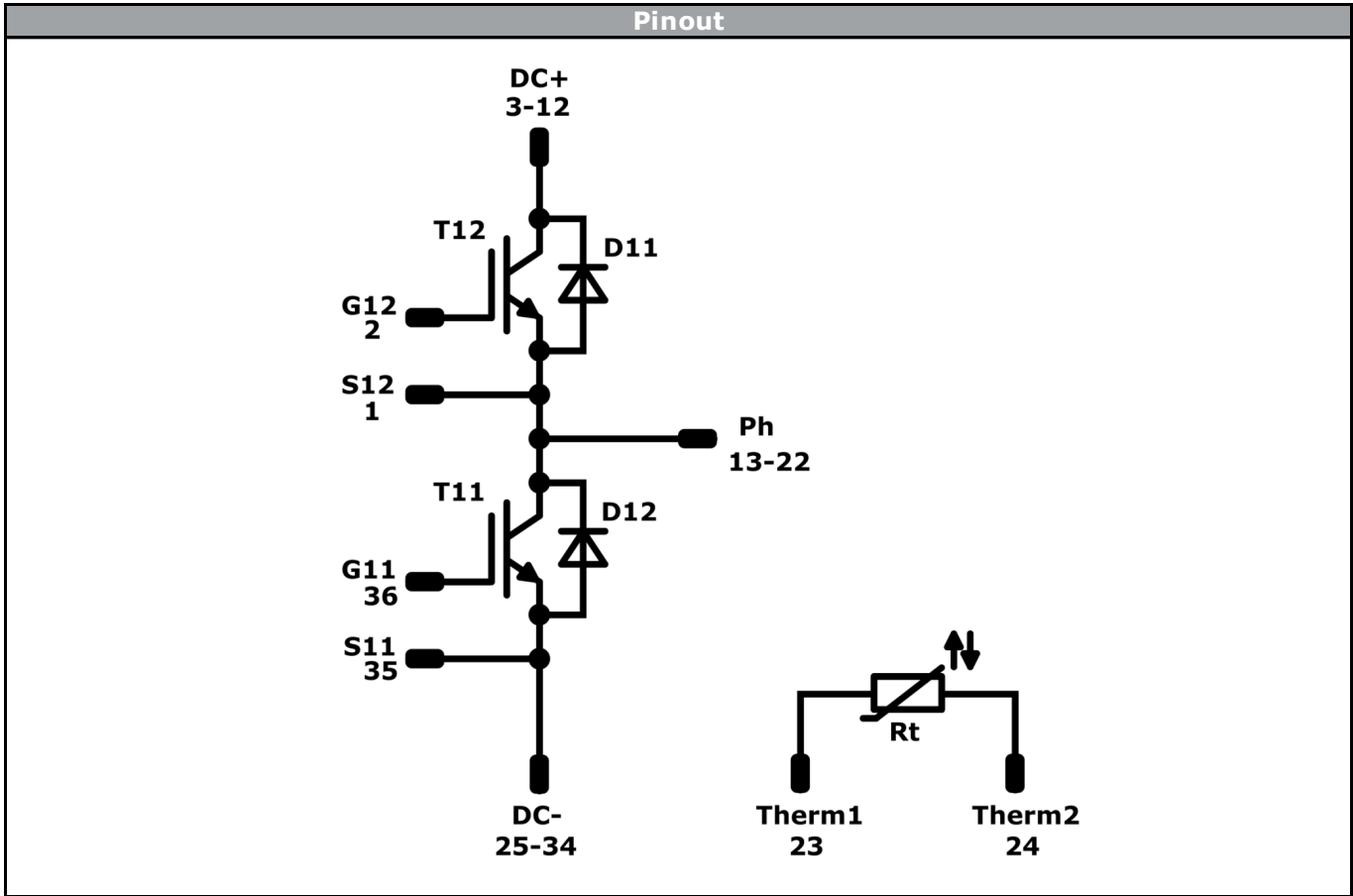
target datasheet

Ordering Code & Marking								
Version			Ordering Code					
with std lid (black V35990-K22-T-2-PM) and without thermal paste			80-M2072PA200SC-K705F40-/0A/					
NN-NNNNNNNNNNNNNN TTTTTV WWYY UL VIN LLLLL SSSS  			Name		Date code	UL & VIN	Lot	Serial
			NN-NNNNNNNNNNNNNN-TTTTTTV		WWYY	UL VIN	LLLLL	SSSS
			Type&Ver	Lot number	Serial	Date code		
Datamatrix	TTTTTTTV	LLLLL	SSSS	WWYY				





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Identification					
ID	Component	Voltage	Current	Function	Comment
T11, T12	IGBT	650 V	200 A	Half-Bridge Switch	
D11, D12	FWD	650 V	200 A	Half-Bridge Diode	
Rt	Thermistor			Thermistor	



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80-M2072PA200SC-K705F40
target datasheet

Packaging instruction			
Standard packaging quantity (SPQ) 72	>SPQ	Standard	<SPQ Sample

Handling instruction
Handling instructions for MiniSkiiP® 2 packages see vincotech.com website.

Package data
Package data for MiniSkiiP® 2 Dual packages see vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
80-M2072PA200SC-K705F40-T1-14	21 Apr. 2016		

Product status definition		
Datasheet Status	Product Status	Definition
Target	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice. The data contained is exclusively intended for technically trained staff.

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.